

2.0A Sensitive Gate SCRs

Product Summary

Symbol	Value	Unit
$I_{T(AV)}$	2.0	A
$V_{DRM} V_{RRM}$	600	V
I_{GT}	200	uA

Features

With high ability to withstand the shock loading of large current, Provide high dv/dt rate with strong resistance to electromagnetic interference.

Application

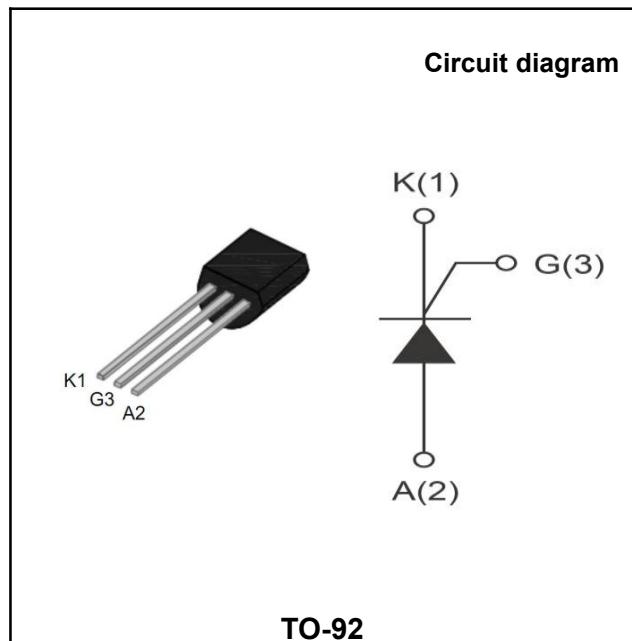
Power charger, T-tools, massager, solid state relay, AC Motor speed regulation and so on.

Order Information

Part Number	Package	Marking	Packing	Packing Quantity
2P4M	TO-92	2P4M XXXX	Box	1000PCS/Box

Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Repetitive peak off-state voltage	V_{DRM}	600	V
Repetitive peak reverse voltage	V_{RRM}	600	V
RMS on-state current	$I_T(RMS)$	3	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)	I_{TSM}	20	A
I^2t value for fusing ($t_p=10ms$)	I^2t	2	A^2s
Critical rate of rise of on-state current ($I_G = 2 \times I_{GT} $)	dI_T/dt	50	A/us
Peak gate current	I_{GM}	0.2	A
Average gate power dissipation	$P_G (AV)$	0.1	W
Junction Temperature	T_J	-40~+110	°C
Storage Temperature	T_{STG}	-40 ~+150	°C



TO-92

Electrical characteristics (TA=25°C, unless otherwise noted)

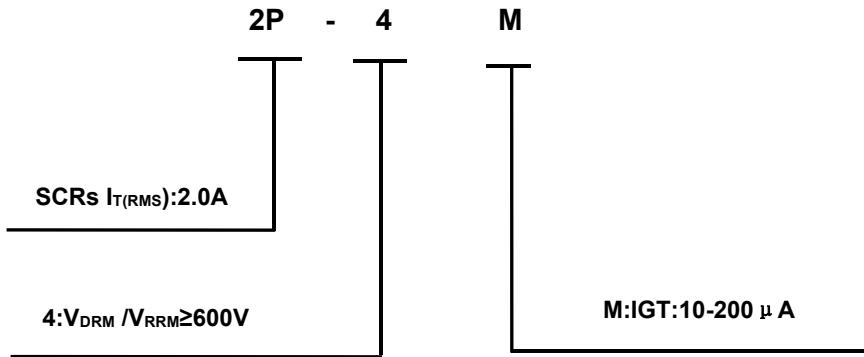
Parameter	Symbol	Test Condition	Value		Unit
			Min	Max	
Gate trigger current	I_{GT}	$V_D=12V$ $I_T=10mA$ $T_j=25^\circ C$	10	200	μA
Gate trigger voltage	V_{GT}		-	0.8	V
Gate non-trigger voltage	V_{GD}	$V_D = 1/2 V_{DRM}$ $T_j = 110^\circ C$	0.2	-	V
latching current	I_L	$V_D = 12V$ $I_G = 0.5mA$ $R_{GK} = 1k\Omega$ $T_j = 25^\circ C$	-	3	mA
Holding current	I_H		-	4	mA
Critical-rate of rise of commutation voltage	dV_D/dt	$V_D = 2/3 V_{DRM}$ Gate Open $T_j = 110^\circ C$	10	-	V/us

STATIC CHARACTERISTICS

Forward "on" voltage	V_{TM}	$I_{TM} = 4A$ $t_p = 380\mu s$	-	1.55	V
Repetitive Peak Off-State Current	I_{DRM}	$V_D = V_{DRM}$ $V_R = V_{RRM}$	$T_j = 25^\circ C$	-	μA
Repetitive Peak Reverse Current	I_{RRM}		$T_j = 110^\circ C$	-	mA

THERMAL RESISTANCES

Thermal resistance	$R_{th(j-c)}$	Junction to case(AC)	TYP.	60	$^\circ C/W$
	$R_{th(j-a)}$	Junction to ambient	TYP.	150	$^\circ C/W$

Ordering Information


Typical Characteristics

FIG.1: Maximum power dissipation versus RMS on-state current (full cycle)

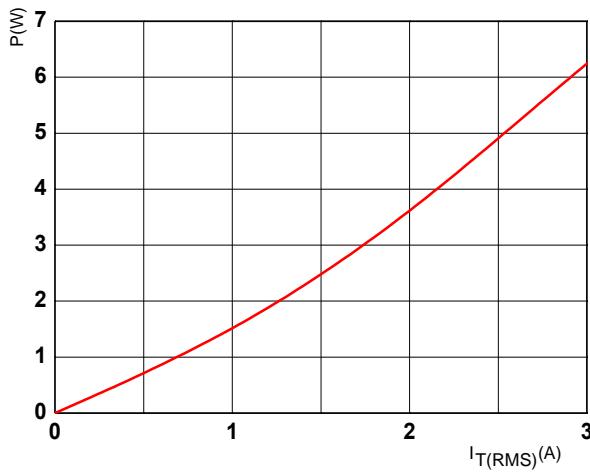


FIG.2: RMS on-state current versus case temperature (full cycle)

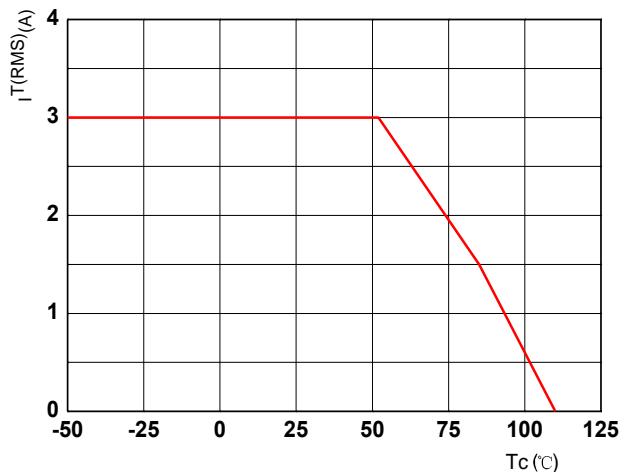


FIG.3: Surge peak on-state current versus number of cycles

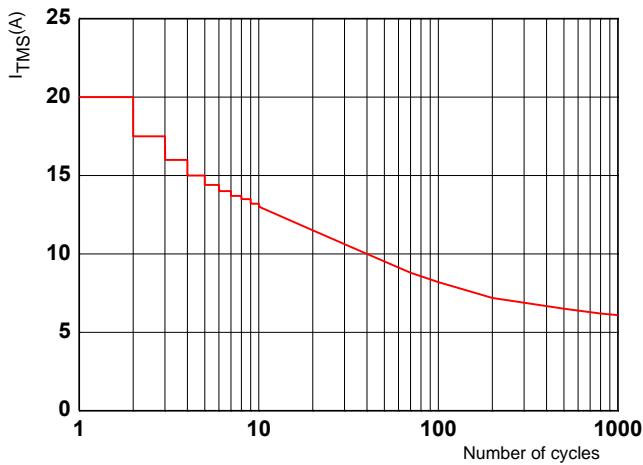


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp < 10ms

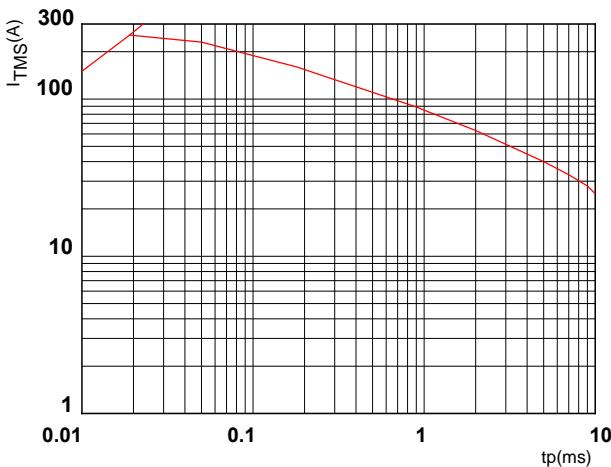


FIG.4: On-state characteristics (maximum values)

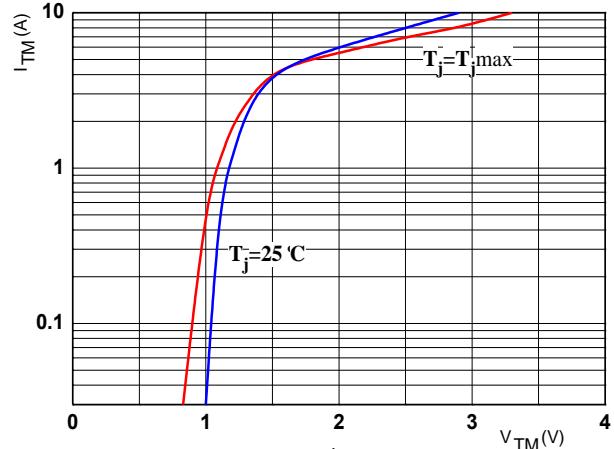
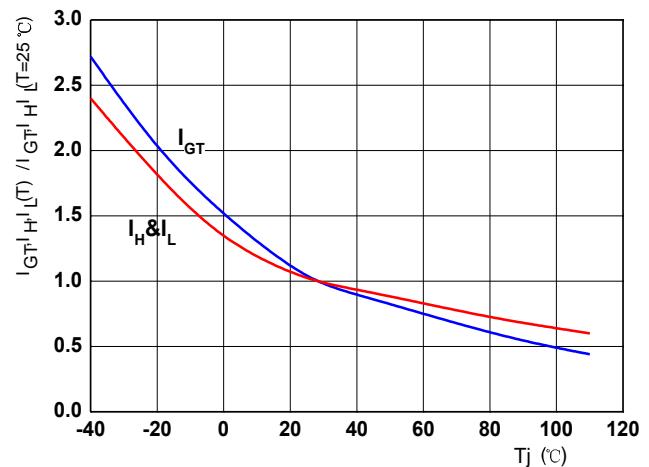
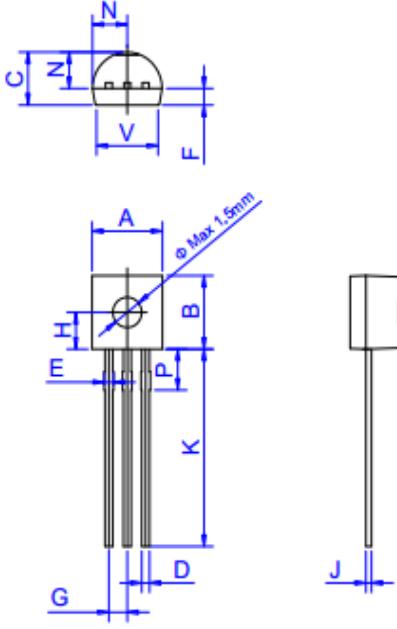


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature (typical values)



Package Information

TO-92



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.45		5.20	0.175		0.205
B	4.32		5.33	0.170		0.210
C	3.18		4.19	0.125		0.165
D	0.407		0.533	0.016		0.021
E	0.60		0.80	0.024		0.031
F	-	1.1	-	-	0.043	-
G	-	1.27	-	-	0.050	-
H	-	2.30	-	-	0.091	-
J	0.36		0.50	0.014		0.020
K	12.70		15.0	0.500		0.591
N	2.04		2.66	0.080		0.105
P	1.86		2.06	0.073		0.081
V	-		4.3	-		0.169